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First Named Inventor: KEITH EDWARDS
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Attorney Docket Number: AMKOR083C



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Title of Invention	LEADFRAME PACKAGE FOR SEMICONDUCTOR DEVICES									
Application Number: 10/781220 Date: 2004-02-18 First Named Applicant: KEITH M.										
Confirmation Number: 1929 Attorney Docket Number: AMKOR083C										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>IDS2-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	IDS2-usidst.xml		us-ids.dtd		us-ids.xsl
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Electronic Version v18

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Signature

Examiner Name	Date